

General Description

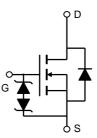
The AO4488 uses advanced trench technology to provide excellent R_{DS(ON)} with low gate charge.

This device is ESD protected and it is suitable for use as a load switch or in PWM applications.

Features

$V_{DS}(V) = 30V$	
I _D = 20A	$(V_{GS} = 10V)$
$R_{DS(ON)} < 4.6m$	$\Omega (V_{GS} = 10V)$
$R_{DS(ON)} < 6.4m$	$\Omega (V_{\rm GS} = 4.5 \text{V})$





Absolute Maximum	Ratings T _A =25℃ unles	s otherwise no	ted			
Parameter		Symbol	10 Sec	Steady State	Units	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	±20		V	
Continuous Drain	T _A =25℃		20	15		
Current ^A	T _A =70℃	I _D	17	12	٨	
Pulsed Drain Current ^B		I _{DM}	80		A	
Avalanche Current G		I _{AR}	50			
Repetitive avalanche	energy L=0.3mH ^G	E _{AR}	375		mJ	
Power Dissipation ^A	T _A =25℃	-P _D	3.1	1.7	W	
	T _A =70℃	ГD	2.0	1.1	vv	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150		C	

Thermal Characteristics						
Parameter		Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{ extsf{ heta}JA}$	31	40	°C/W	
Maximum Junction-to-Ambient ^A	Steady State	ιν _{θJA}	59	75	C/W	
Maximum Junction-to-Lead ^C	Steady State	$R_{ extsf{ heta}JL}$	16	24	C/W	



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Мах	Units
STATIC P	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$		30	35.5		V
Zara Cata Valtaga Drain Curran	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$				1	
I _{DSS}			T _J = 55℃			5	μA
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 16V$				±10	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$		1.0	1.7	2.5	V
I _{D(ON)}	On state drain current	$V_{GS} = 10V, V_{DS} = 5V$		80			А
		$V_{GS} = 10V, I_{D} = 20A$			3.8	4.6	
R _{DS(ON)}	Static Drain-Source On-Resistance		T_=125℃		5.3	6.5	mΩ
		$V_{GS} = 4.5V, I_{D} = 18A$			5.2	6.4	
g fs	Forward Transconductance	$V_{DS} = 5V, I_{D} = 20A$			72		S
V _{SD}	Diode Forward Voltage	$I_{\rm S} = 1 {\rm A}, V_{\rm GS} = 0 {\rm V}$			0.69	1	V
ls	Maximum Body-Diode Continuous Curre	rent			3	А	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			5450	6800	pF
C _{oss}	Output Capacitance				760		pF
C _{rss}	Reverse Transfer Capacitance				540		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			1	1.5	Ω
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =20A			84	112	nC
Q _g (4.5V)	Total Gate Charge				42	56	nC
Q _{gs}	Gate Source Charge				12		nC
Q _{gd}	Gate Drain Charge				21		nC
t _{D(on)}	Turn-On DelayTime				13		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_{L} =0.75 Ω , R_{GEN} =3 Ω			9.8		ns
t _{D(off)}	Turn-Off DelayTime				49		ns
t _f	Turn-Off Fall Time]	ſ		16		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, dl/dt=100A/μs			42	56	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =20A, dl/dt=100A/µs			31		nC

A: The value of R_{6JA} is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\rm \theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\rm \theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < 300μ s pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t \leqslant 10s thermal resistance rating.

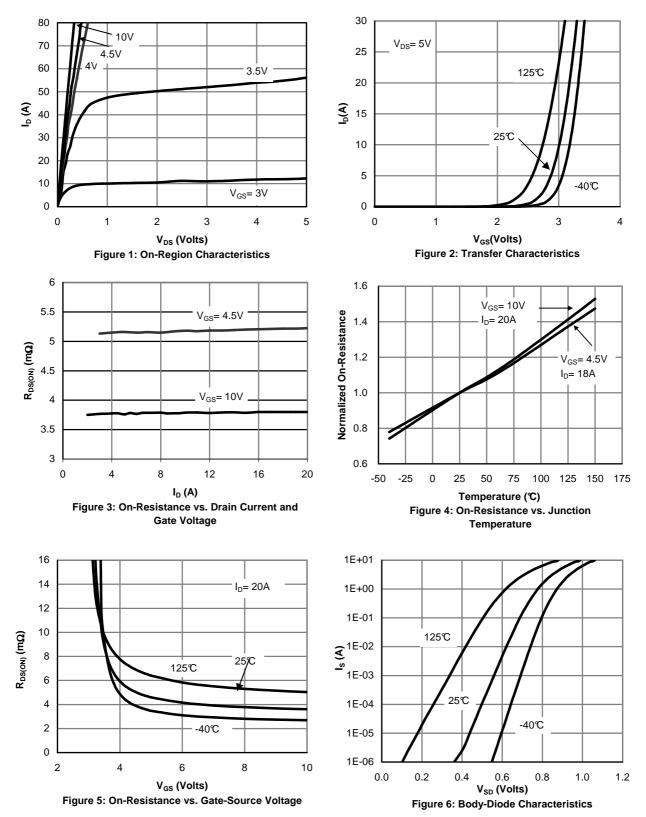
G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep T_j =25C.

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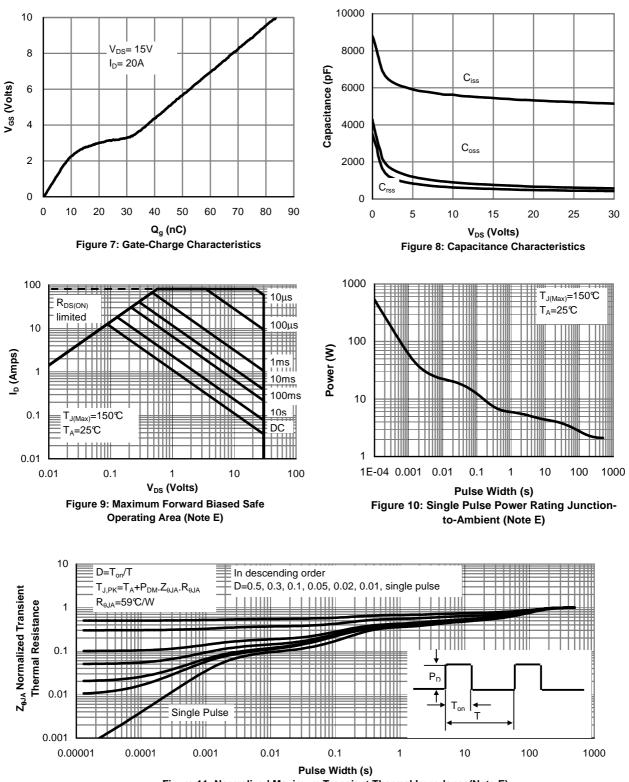
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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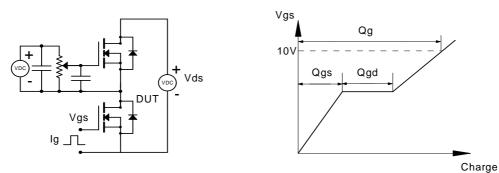
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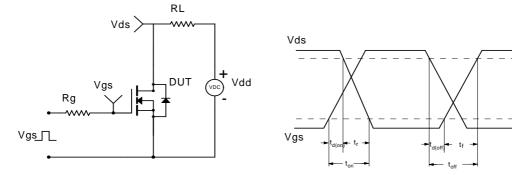
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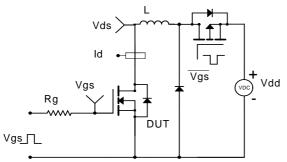
Gate Charge Test Circuit & Waveform

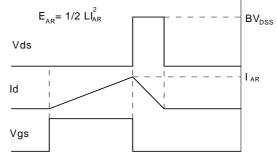


Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





<u>9</u>0%

10%

Diode Recovery Test Circuit & Waveforms

